

BASiC

B2D20065H

650V A 20A A SIC SCHOTTKY DIODE

SILICON CARBIDE SiC SCHOTTKY DIODE ▲ THT type Excellent surge capability Easy paralleling due to positive V_F temperature coefficient TO-247-2L package ▲ Epoxy meets UL94-V0 Temperature independent switching Ultra-low forward voltage and high surge current





FREE

RoHS

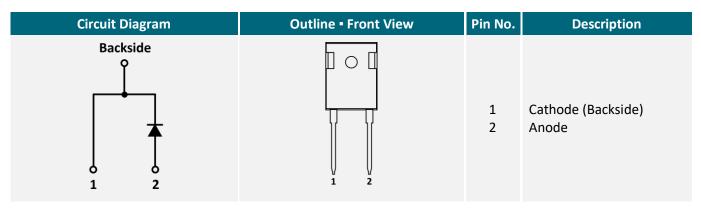


Item (T _c = 25°C, unless otherwise noted)	Characteristics	
Operating Temperature Range	TJ	-55°C to +175°C
Storage Temperature Range	Ts	-55°C to +175°C
Repetitive Peak Reverse Voltage	V _{RRM}	650V
Continuous Forward Current at T _c = 155°C	I _F	20A
Total Capacitive Charge (TJ = 25°C)	Qc	64nC
Capacitance Stored Energy ($V_R = 400V$)	Ec	16µЈ
Diode Forward Voltage (T _J = 175° C, I _F = $20A$)	V _F	1.63V
Power Dissipation	Ρ _{τοτ}	252W

APPLICATIONS

EV Charging	Industrial Inverters	Motors & Drives	Power Factor Correction	Renewable Energy	SMPS	UPS
€Ո≢			PFC	*		

PIN DESCRIPTION



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ABSOLUT MAXIMUM RATINGS **A** T_c = 25°C, unless otherwise noted

ltem	Condition	Symbol		Unit
Repetitive Peak Reverse Voltage		V _{RRM}	650	V
Non-Repetitive Peak Reverse Voltage		V _{RSM}	650	V
Continuous Forward Current	T _c = 25°C	IF	68	А
Continuous Forward Current	T _C = 155°C	IF	20	А
Non-Repetitive Forward Surge Current	T_{C} = 25°C, t_{p} = 10ms, Half Sine Wave	I _{FSM}	160	А
I ² t Value	T _c = 25°C, t _p = 10ms	∫i²dt	128	A ² s
Power Dissipation	T _C = 25°C	P _{TOT}	252	W
Power Dissipation	T _C = 110°C	P _{TOT}	109	W
Operating Junction Temperature		TJ	-55 to +175	°C
Storage Temperature Range		T _{STG}	-55 to +175	°C
TO-247 Mounting Torque	M3 Screw		0.7	Nm

ELECTRICAL CHARACTERISTICS

Item	Condition	Symbol	Min.	Тур.	Max.	Unit
Static Characteristics						
DC Blocking Voltage	T _J = 25°C	V _{DC}	650			V
Diode Forward Voltage	I _F = 20A, T _J = 25°C	V _F		1.28	1.60	V
Diode Forward Voltage	I _F = 20A, T _J = 175°C	VF		1.63	2.60	V
Reverse Current	$V_R = 650V, T_J = 25^{\circ}C$	I _R		1	120	μΑ
Reverse Current	V _R = 650V, T _J = 175°C	I _R		20	200	μA
Item	Condition	Symbol	Min.	Тур.	Max.	Unit
Dynamic Characteristics						
	$V_{R} = 400V, T_{J} = 25^{\circ}C$					
Total Capacitive Charge	$Q_C = \int_0^{V_R} C(V) dV$	Qc		64		nC
Total Capacitance	$V_{R} = 1V$, f = 1MHz, T _J = 25°C	С		998		рF
Total Capacitance	V _R = 300V, f = 1MHz, T _J = 25°C	С		110		pF
Total Capacitance	V _R = 600V, f = 1MHz, T _J = 25°C	С		109		pF
Capacitance Stored Energy	V _R = 400V, T _J = 25°C	Ec		16		μ

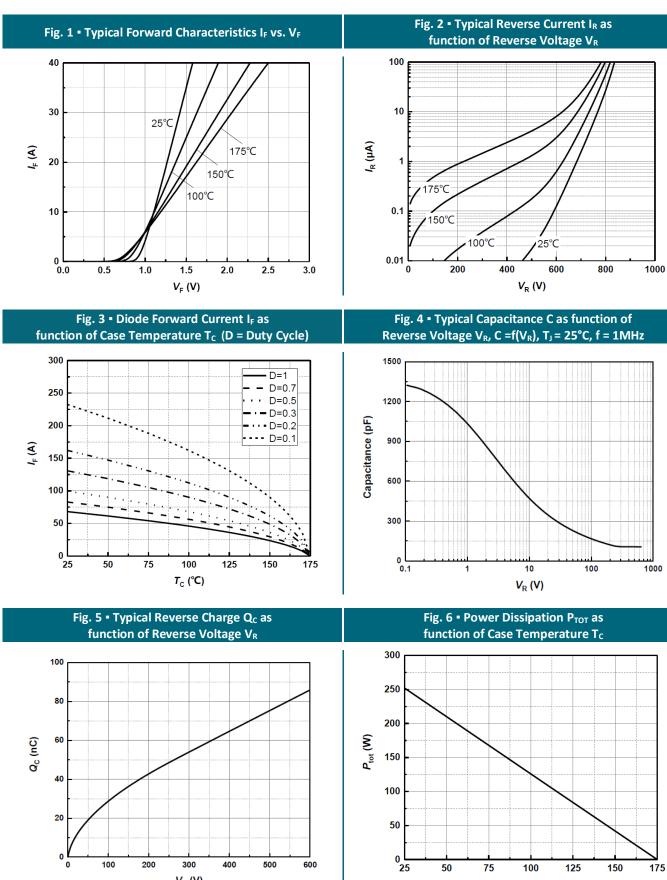
THERMAL RESISTANCE PERFORMANCE

Item	Symbol	Min.	Тур.	Max.	Unit
Thermal Resistance, Junction to Case	R _{θ,JC}		0.590		K/W

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REFERENCE DATA A TYPICAL PERFORMANCE



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200

300

V_R (V)

400

500

100

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600

50

75

100

*T*_c (°C)

125

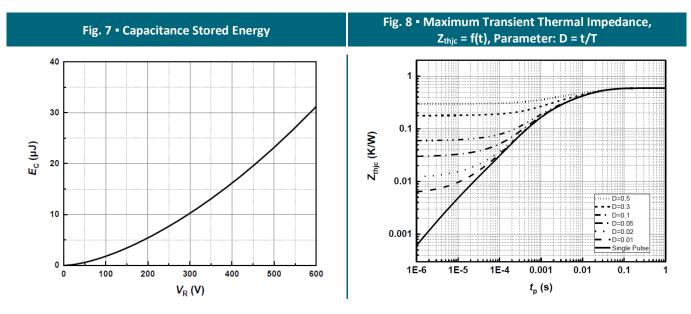
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150

175



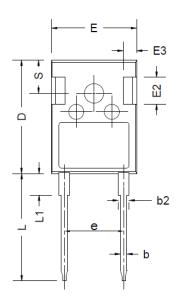
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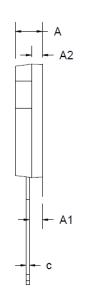


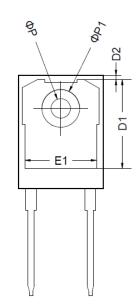




PACKAGE OUTLINE







Sym	Millimeters (Min.)	Millimeters (Typ.)	Millimeters (Max.)	Sym	Millimeters (Min.)	Millimeters (Typ.)	Millimeters (Max.)
А	4.80	5.00	5.20	E1	13.00	13.30	13.60
A1	2.21	2.41	2.61	E2	4.80	5.00	5.20
A2	1.85	2.00	2.15	E3	2.30	2.50	2.70
b	1.11	1.21	1.36	е		10.88 BSC	
b2	1.91	2.01	2.21	L	19.62	19.92	20.22
С	0.51	0.61	0.75	L1	-	-	4.30
D	20.80	21.00	21.30	ØР	3.40	3.60	3.80
D1	16.25	16.55	16.85	ØP1	-	-	7.30
D2	1.05	1.17	1.35	S		6.15 BSC	
E	15.50	15.80	16.10				

ORDERING INFORMATION

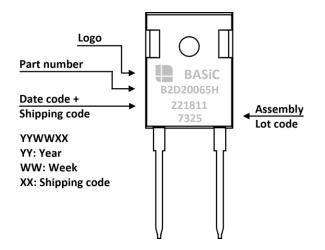
Part Number	Package	Packing	Tube Qty.	Inner Box Qty.	Outer Box Qty.
B2D20065H	TO-247-2L	Tube	30pcs	600pcs	3,000pcs

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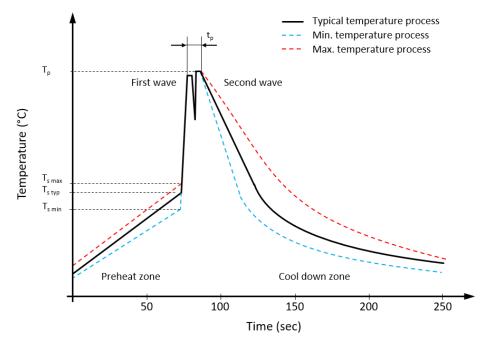


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PART MARKING



RECOMMENDED WAVE SOLDERING PROFILE ▲ THT PACKAGE



Classification wave soldering profile ▲ Refer to EN 61760-1: 2006

Profile Features		Value 🛦 Sn-Pb Assembly	Value 🔺 Pb-free Assembly
Preheat temperature min.	$T_{s min}$	100 °C	100 °C
Preheat temperature typical	T _{s typ}	120 °C	120 °C
Preheat temperature max.	$T_{s max}$	130 °C	130 °C
Preheat time t_s from $T_{s min}$ to $T_{s max}$	ts	70 seconds	70 seconds
Peak temperature	Τ _p	235 °C to 260 °C	245 °C to 260 °C
Time of actual peak temperature	t _p	Max. 10 seconds Max. 5 second each wave	Max. 10 seconds Max. 5 second each wave
Ramp-down date min.		~ 2 °C/second	~ 2 °C/second
Ramp-down rate typical		~ 3.5 °C/second	~ 3.5 °C/second
Ramp-down rate max.		~ 5 °C/second	~ 5 °C/second
Time 25°C to 25°C		4 minutes	4 minutes
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REVISION TABLE

Revision	Date	Status	Notes
001	30/09/2022	Initial release	Initial publication

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